



# SPECIFICATION

# Product model: PV10109LZR40G

DESIGNED	CHECKED	Approved
研发部	研发部	研发部
2020.07.28	2020.07.28	2020.07.28
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# Approval by Customer:

# Customer name:

# Customer model:

Ok

NG, Problem survey

Approved By\_\_\_\_





# **Revision Record**

REV NO.	<b>REV DATE</b>	CONTENTS	Note
V0	2020 04 09	NEW ISSUE	
V1	2020 04 29	Updated parameter	6,11,15
V2	2020 07 28	Added Idd	





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#### 1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by Kingtech Group Co.,Ltd.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

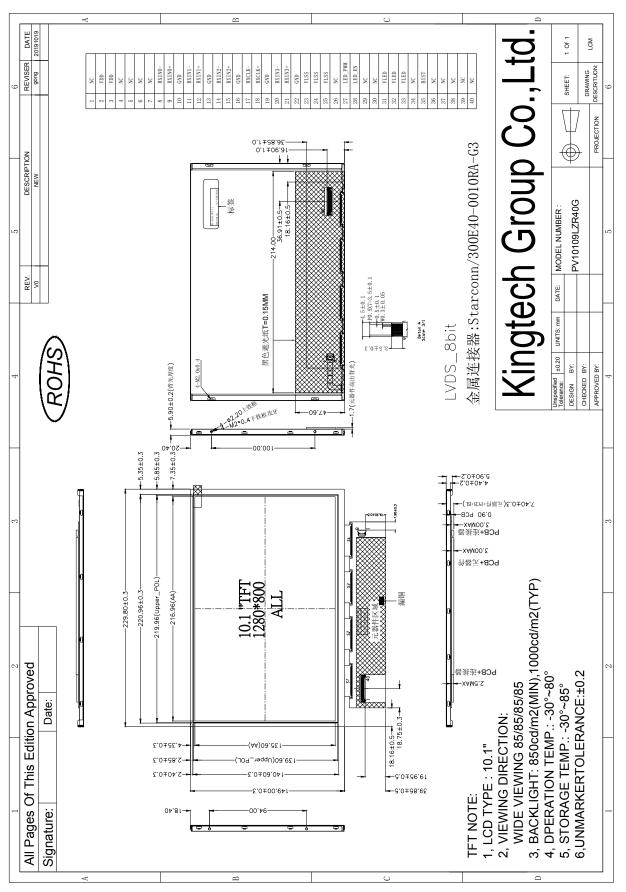
### 2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	10.1"TFT	
Dot arrangement	1280×3(RGB)×800	dots
Color filter array	RGB vertical stripe	
Display mode	Normally Black	-
Viewing Direction	85/85/85	
Module size	229.8(W)×149(H)×5.9(T)	mm
Active area	216.96(W)×135.60(H)	mm
Dot pitch	0.1695(W)×0.1695(H)	mm
Interface	LVDS 8bit	
Operating temperature	-30 ~ +80	°C
Storage temperature	-30 ~ +85	°C
Weight	TBD	g





# 3. External Dimensions







### 4. Interface Description

PIN	PIN NAME	DESCRIPTION						
1	NC	No connection						
2	VDD	Power Supply						
3	VDD							
4	NC							
5	NC	No connection						
6	NC							
7	NC	No connection						
8	RXIN0-	-LVDS Differential Data Input						
9	RXIN 0+	+LVDS Differential Data Input						
10	GND	Ground						
11	RXIN 1-	-LVDS Differential Data Input						
12	RXIN 1+	+LVDS Differential Data Input						
13	GND	Ground						
14	RXIN 2-	-LVDS Differential Data Input						
15	RXIN 2+	+LVDS Differential Data Input						
16	GND	Ground						
17	RXCLK-	-LVDS Differential Clock Input						
18	RXCLK+	+LVDS Differential Clock Input						
19	GND	Ground						
20	RXIN 3-	-LVDS Differential Data Input						
21	RXIN 3+	+LVDS Differential Data Input						
22	GND	Ground						
23	VLSS							
24	VLSS	Ground						
25	VLSS							
26	NC	No connection						
27	LED_PWM	CABC controller signal output for backlight						
28	LED_EN	CABC Enable Input						
29	NC	No connection						
30	NC	No connection						
31	VLED							
32	VLED	VIN Voltage(12V TYP)						
33	VLED							
34	NC	No connection						
35	BIST	No connection						
36	NC	No connection						
37	NC	No connection						
38	NC	No connection						
39	NC	No connection						
40	NC	No connection						
27 28 29 30 31 32 33 33 34 35 36 37 38 39	LED_PWM LED_EN NC VLED VLED VLED NC BIST NC NC NC NC	CABC controller signal output for backlight CABC Enable Input No connection No connection VIN Voltage(12V TYP) No connection No connection No connection No connection No connection No connection No connection						

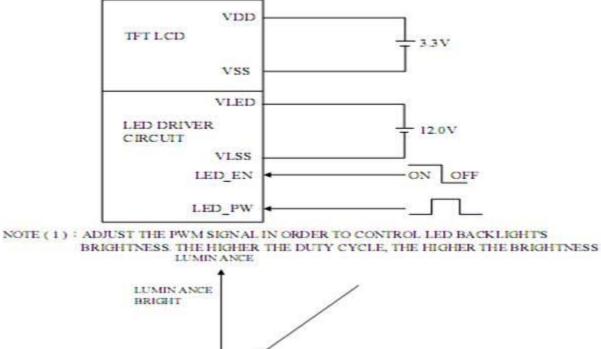




#### 5. Absolute Maximum Ratings

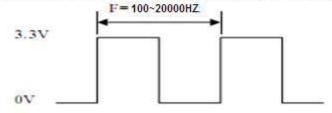
ltem	Symbol	Min.	Max.	Unit	Remark
Digital Supply Voltage	VDD	-0.3	4.0	V	
VIN Voltage	VLED	-0.3	50	V	
Operating Temperature	Тор	-30	80	°C	
Storage Temperature	Тѕт	-30	85	°C	

## 5.1 POWER SUPPLY FOR LCM





NOTE (2) : PWM SIGNAL=0~3.3V · OPERATION FREQUENCY : 100-20000HZ



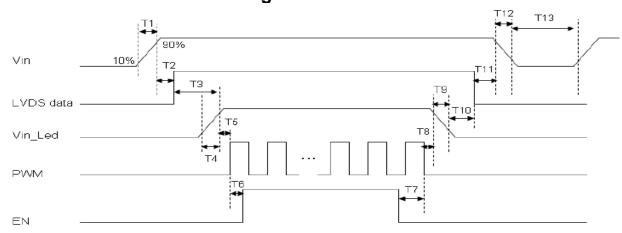
# KINGTECH



# 6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Digital Supply Voltage	VDD	2.75	3.3	3.6	V	
Digital Supply Current	IDD	-	400	480	mA	VDD=3.3V
VIN Voltage	VLED	4.5	-	40		
Input logic high voltage	Vін	0.7*VDD	-	VDD	V	
Input logic low voltage	VIL	GND	-	0.3*VDD	V	

# 7. Timing Characteristics7.1 Power On and Reset Timing



Parameter	Symbol	Unit	Min	Тур.	Max	
VIN Rise Time	T1	ms	0.5		10	
VIN Good to Signal Valid	T2	ms	30		90	
Signal Valid to Backlight On	ТЗ	ms	200			
Backlight Power On Time	T4	ms	0.5			
Backlight VDD Good to System PWM On	🕨 Т5	ms	10			
System PWM ON to Backlight Enable ON	Т6	ms	10			
Backlight Enable Off to System PWM Off	Т7	ms	0			
System PWM Off to B/L Power Disable	Т8	ms	10			
Backlight Power Off Time	Т9	ms	0.5	10	30	
Backlight Off to Signal Disable	T10	ms	200			
Signal Disable to Power Down	T11	ms	0		50	
VIN Fall Time	T12	ms	0.5	10	30	
Power Off	T13	ms	500			



# 7.2 LVDS Signal Timing Characteristics

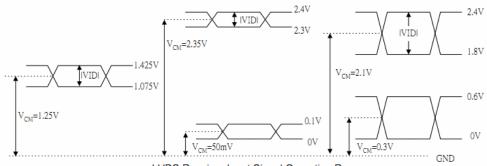
### 7.2.1 DC Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max	Unit
V <sub>TH</sub>	Differential Input High Threshold		-	-	100	mV
V <sub>TL</sub>	Differential Input Low Threshold	V <sub>CM</sub> =+1.2V	-100	-	-	mV
Icc	Average Supply Current		-	TBD	-	mA

Typical Input Swim

Minimum Input Swim

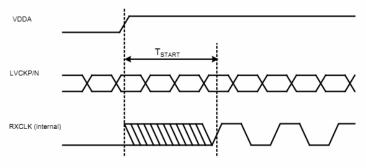
Maximum Input Swim

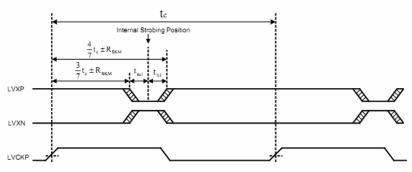


LVDS Receiver Input Signal Operation Range

# 7.2.2 AC Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max	Unit
_		RX_HF=0	25	-	100	MHz
F <sub>OP</sub>	Input Operating Frequency range	RX_HF=1	100	-	170	MHz
		85MHz,  VID =400mV, V <sub>CM</sub> =1.2V	450	-	-	pS
R <sub>SKM</sub>	Receiver Skew Margin	150MHz,  VID =400mV, V <sub>CM</sub> =1.2V	267	-	-	pS
T <sub>STRAT</sub>	Receiver startup time (after a valid LVDS		_		10	mS
STRAT	clock is applied)		-	-	10	1110





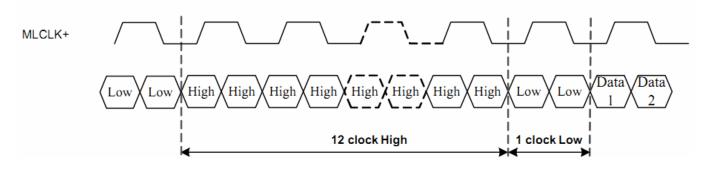
NOTE: LVCK is advanced or delayed with respect to data until errors are observed at the receiver outputs. The advance or delay is then reduced until there are no data errors observed. The magnitude of the advance or delay is RSKM.





# 7.2.3 mini-LVDS Output Timing

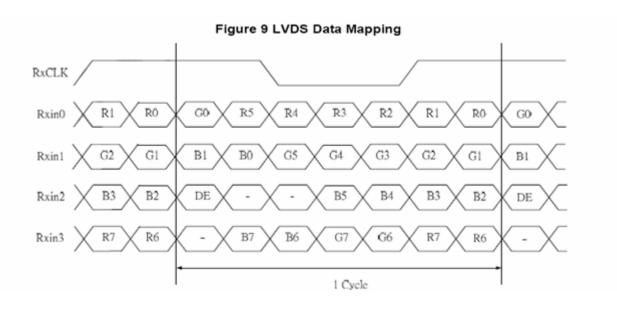
mini-LVDS Reset Pules Timing



# 7.2.3 Interface Timings

Parameter	Symbol	Unit	Min.	Тур.	Max.
Frame Rate	- 4	Hz	-	60	-
Frame Period	tV	line	(815)	(823)	(1023)
Vertical Display Time	tVD	line		800	
Vertical Blanking Time	tVW+tVBP+tVFP	line	(15)	(23)	(33)
1 Line Scanning Time	tH	clock	(1410)	(1440)	(1470)
Horizontal Display Time	tHD	clock		1280	
Horizontal Blanking Time	tHW+tHBP+tHFP	clock	(60)	(160)	(190)
Clock Rate	1/TC	MHz	(68.9)	(71.1)	(73.4)
	•	•			

# 7.2.5 LVDS Data MApping







### 8. Backlight Characteristic

ltem		Symbol	MIN	TYP	MAX	UNIT	NOTE	
Backlight Powe	er	VLED	8	12	15	V	Ta = 25°C	
Backlight Powe	er	IVLED	-	0.5	0.8	А	VLED=12V	
EN Signal Volta	VIH	LED EN	1.65		5.25	V		
ge	VIL		GND		0.4	V		
Luminous Intensi	VIH		0.8Ven		5.25	V		
ty for LCM	VIL	LED_PWM	GND		0.2Ven	V		
PWM Frequen	су	LED_PWM	100		20000	Hz		
Lifetime			50000	-	-	Hr		
Color		White						
Average Brightn	Average Brightness		850	1000	-	Cd/cm2		
Luminance unifor	mity	-	80	-	-	%		

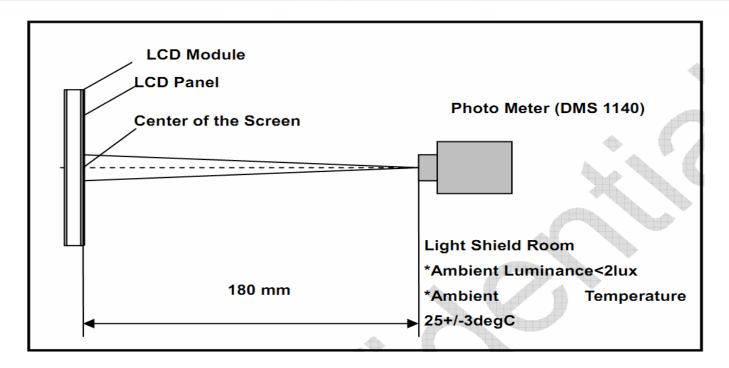
## 9. Optical Characteristics

Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θ∟	-	85	-	degree		
Viewing Angle		θR	-	85	-		(1),(2),(6)	
(CR>10)	Vertical	θт	-	85	-			
		θв	-	85	-			
Contrast Ratio	Center		600	800	-	-	(1),(3),(6)	
Response Time	Rising			25	35	ms	(1),(4),(6)	
Response nine	Falling							
	Red x			0.610	Тур.	-	(1), (6)	
	Red y			0.335		-		
	Green x			0.340		-		
CF Color	Green y			0.595		-		
Chromaticity (CIE1931)	Blue x		Тур.	0.155		-		
(	Blue y White x		-0.05	0.205	+0.05	-	-	
				0.340		-		
	White y			0.370		-		

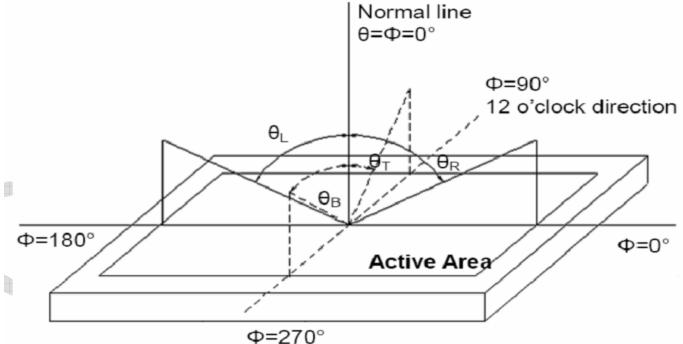
Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.







Note (2) Definition of Viewing Angle



Note (3) Definition of Contrast Ratio (CR)

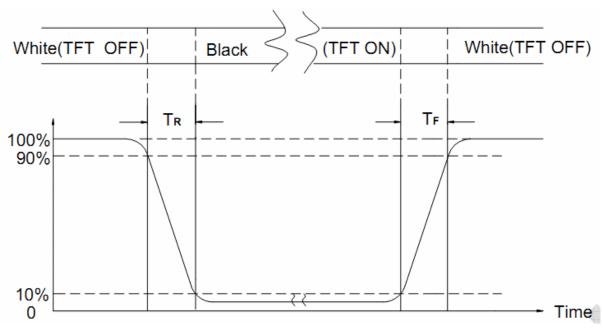
The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time







Note (5) Definition of Transmittance (Module is without signal input) Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD





## **10. Reliability Test Conditions and Methods**

NO.	TEST ITEMS	TEST CON	IDITION	
1	High Temperature Storage	Keep in 85°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs		
2	Low Temperature Storage	Keep in -30°C $\pm$ 5°C 96 hrs Surrounding temperature, then storage at normal condition		
3	High Temperature Operating Test	80℃*96Hrs		
4	Low Temperature Operating Test	-30℃*96Hrs		
5	High Temperature / High Humidity Operating Test	60 ℃ / 90% R.H , 96 hrs.		
6	High Temperature / High Humidity Storage Test	Keep in 60 ${}^\circ\!\!{\rm C}$ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs.		
7	Temperature Cycling Storage Test	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		
		Air Discharge: Apply 6 KV with 5 times Discharge for each polarity +/-Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-		
8 ESD Test		<ol> <li>Temperature ambiance : 15°C~35°C</li> <li>Humidity relative : 30%~60%</li> <li>Energy Storage Capacitance( Cs + Cd ) : 150pF±10%</li> <li>Discharge Resistance(Rd) : 330Ω±10%</li> <li>Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)</li> </ol>		
9	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X ∖ Y ∖ Z) duration for 2 Hrs</li> </ol>		
(10)	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45 4 45.4 ~ 90.8 90.8 ~ 454 Over 454	Drop Height (cm) 122 76 61 46	

PS: ①~ ⑦ test exclude Polaroid;





### **11. Inspection Standard**

#### 11.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

#### **11.1.1. THE METHOD OF PRESERVING GOODS**

AFTER DELIVERY OF GOODS FROM KINGTECH TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

#### **11.1.2. INCOMING INSPECTION**

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

#### (B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E ) ,LEVEL:

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

#### **11.1.3. WARRANTY POLICY**

KINGTECHWILL PROVIDE ONE-YEAR WARR ANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. KINGTECH WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF KINGTECH.

#### **11.2. CHECKING CONDITION**

**11.2.1.**CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.

**11.2.2.** CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE **Ambient Illumination:** 

Functional detection in 1000 nits backlight environment

Appearance detection in 800~1000 Lux external environment





#### 11.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA 	Minor
	6. BLEMISH V BLACK SPOT V WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH • BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR ( OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE ( IF NEEDED, AND INSIDE VIEWING AREA )	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS ( CONTRAST, VOP, CHROMATICITY ETC )	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA )	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT · LINE · CHARACTER REJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY VRONG PATTERN DISPLAY CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT	ACCORDING TO STANDARD OF VISUAL	Minor



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NO.	CLASS	ITEM	JUDGEM	ENT
			(A) ROUND TYPE:	unit : mm.
			DIAMETER (mm.) ACC	EPTABLE Q'TY
			Φ ≤ 0.15	Distance≥1mm
		BLACK AND WHITE SPOT	0.15 < Φ ≦ 0.4	3 (Distance>15mm)
		BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH	0.4 < Φ	0
11.4.1	MINOR		NOTE: $\Phi = (\text{LENGTH+WIDTH})/2$ (B) LINEAR TYPE:	unit : mm.
		SCRATCH	LENGTH WIDTH	ACCEPTABLE Q'TY
		boltarion	W ≦0.0	3 Distance>1mm
			L ≦ 4.0 0.03 < W ≦0.0	5 3 (Distance>15mm)
			0.05 < W	FOLLOW ROUND TYPE
		5 <u> </u>		unit : mm.
		DIAMETER AC	CCEPTABLE Q'TY	
		BUBBLE IN POLARIZER	Φ ≤ 0.2	Distance≥1mm
11.4.2	MINOR			3 (Distance>15mm)
			0.5 < Φ	0
		Dot Defect	Items	ACC. Q'TY
				≦2 (Distance≥15mm)
			Dark dot N	3 (Distance>15mm)
11.4.3 M	MINOR		Pixel Define : Pixel	e of a defective dot over as one defective dot. ble by $5\%$ ND filter N $\leq 5$ at and unchanged in size ying under black pattern. and unchanged in size in
1.4.4	MINOR	Mura	Not visible thriugh 5% ND filter in by limit sample if necessary	50% gray or judge

,





NO.	CLASS	ITEM	JUDGEMENT
11.4.5	MINOR	LCD GLASS CHIPPING	X≥3mm Y>S Reject
11.4.6	MINOR	LCD GLASS CHIPPING	X or Y > S Reject
11.4.7	MAJOR	LCD GLASS GLASS CRACK	T T T T NG Reject
11.4.8	MAJOR	LCD GLASS SCRIBE DEFECT	ACCORDING TO DIMENSION
11.4.9	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL AREA )	$Y < 1/2Z$ $Y \ge 0.5mm_{Reject}$ $X \ge 3mm$
11.4.10	MINOR	LCD GLASS CHIPPING ( ON THE TERMINAL SURFACE )	$Y < 1/2Z$ $Y \ge 0.5mm_{Reject}$ $X \ge 3mm$
11.4.11	MINOR	LCD GLASS CHIPPING	$X \ge 3mm$ $Y \ge T$ Reject $X \ge 2mm$ $Y \ge T$ If touch the electrode lines, the need to retain the two-thirds electrode lines



# 12. Handling Precautions

#### 12.1 Mounting method

The LCD panel of KINGTECH TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

#### 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Power or Ground, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

#### 12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

#### 12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.





#### 12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
   [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

#### 12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

### 13. Precaution for Use

#### 13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

#### 13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to KINGTECH TFT ,and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

#### 14. Packing Method

TBD